rohm

- STRUCTURE Silicon Monolithic Integrated Circuit
- ♦ PRODUCT I²C BUS Serial EEPROMs
- ♦ SERIES SIGNATURE SERIES
- ♦ FAMILY BR24C□□ family
- ♦ TYPE

Supply voltage 1.8V \sim 5.5V/Opreating temperature -40°C \sim +85°Ctype

♦ PART NUMBER BR24C□□-R□□6TP

PART NUMBER	PACKAGE	DENSITY
BR24C01-RMN6TP		1Kbit
BR24C02-RMN6TP	7	2Kbit
BR24C04-RMN6TP	SO8 narrow	4Kbit
BR24C08-RMN6TP		8Kbit
BR24C16-RMN6TP		16Kbit
BR24C01-RDW6TP		1Kbit
BR24C02-RDW6TP		2Kbit
BR24C04-RDW6TP	TSSOP8	4Kbit
BR24C08-RDW6TP		8Kbit
BR24C16-RDW6TP		16Kbit
BR24C01-RDS6TP		1Kbit
BR24C02-RDS6TP	TSSOP8	2Kbit
BR24C04-RDS6TP	$3 \times 3 \text{mm}^2$	4Kbit
BR24C08-RDS6TP	3 × 3mm	8Kbit
BR24C16-RDS6TP		16Kbit

♦ FEATURES

Two wire serial interface Endurance : 1,000,000 erase/write cycles Data retention : 40years Intial Data FFh in all address

♦ ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Min	Max	Unit
Tstg	Storage Temperature	-65	125	°C
Vio	Terminal Voltage	-0.3	Vcc+0.3	V
Vcc	Supply Voltage	-0.3	6.5	V

♦ POWER DISSIPATION (Ta=25°C)

PACKAGE	Rating	Unit
SO8 narrow	450 *1	mW
TSSOP8	330 *2	mW
TSSOP8 3 × 3mm ²	310 *3	mW

* Degradation is done at 4.5mW/°C(*1), 3.3mW/°C(*2), 3.1mW/°C(*3) for operation above 25°C



♦ RECOMMENDED OPERATING CONDITION

Symbol	Parameter	Min	Max	Unit
Vcc	Supply Voltage	1.8	5.5	V
T _A	Ambient Operating Temperature	-40	85	°C

♦ DC OPERATING CHARACTERISTICS (Unless otherwise specified Ta=-40~85°C, Vcc=1.8~5.5V)

Parameter	Symbol	Min.	Max.	Unit	Test condition
Input Leakage Current (SCL,SDA)	և	-	±2	μA	V _{IN} =Vss or Vcc
Output Leakage Current	ILO	-	±2	μA	V _{OUT} = Vss or Vcc(SDA in Hi−Z)
Supply Current	Lcc	-	0.8	mA	Vcc=1.8V, f _c =400kHz
Stand-by Supply Current	I _{CC1}	-	0.3	μA	V _{IN} =Vss or Vcc, Vcc=1.8V
Input Low Voltage	VL		0.3Vcc	v	2.5V≦Vcc≦5.5V
(E2,E1,E0,SCL,SDA)	۷L	-	0.2Vcc	ľ	1.8V≦Vcc<2.5V
Input Low Voltage (WC)	v		0.5		2.5V≦Vcc≦5.5V
input Low Voltage (WC)	V _{IL} – 0.2Vcc V		Ň	1.8V≦Vcc<2.5V	
Input High Voltage	V	0.7Vcc		v	2.5V≦Vcc≦5.5V
(E2,E1,E0,SCL,SDA,WC)	VBH	0.8Vcc	_	Ň	1.8V≦Vcc<2.5V
Output Low Voltage	VoL	-	0.2	v	I _{OL} =0.7mA, Vcc=1.8V

OThis product is not designed for protection against radioactive rays.

♦ BLOCK DIAGRAM

♦ AC OPERATING CHARACTERISTICS (Unless otherwise specified Ta=-40~85°C, Vcc=1.8~5.5V)

Parameter	Symbol	Min	Max	Unit
Clock Frequency	fc	-	100	kHz
Clock Pulse Width High	tonci	4000	-	ns
Clock Pulse Width Low	t _{CLCH}	4700	-	ns
SDA Fall Time *1	toLIDL2	20	300	ns
Data In Set Up Time	t _{DXCX}	250	-	ns
Data In Hold Time	t _{CLDX}	0	-	ns
Data Out Hold Time	t _{CLOX}	200	-	ns
Clock Low to Next Data Valid(Access Time)	t _{CLOV}	200	3500	ns
Start Condition Set Up Time	t _{CHDX}	4700	-	ns
Start Condition Hold Time	tDLCL	4000	-	ns
Stop Condition Set Up Time	t _{CHDH}	4000	-	ns
Time between Stop Condition and Next Start Condition	t _{ohdl}	4700	-	ns
Write Time	tw	-	10	ms

*1 Not 100% TESTED

♦ PIN No., PIN NAME

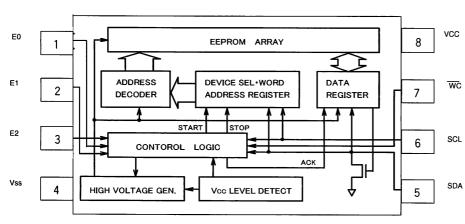


Fig.-1 BLOCK DIAGRAM

 PIN No.
 PIN NAME

 1
 E0

 2
 E1

 3
 E2

 4
 Vss

 5
 SDA

SCL

WC

Vcc

6

7

8

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♦NOTES FOR POWER SUPPLY

Vcc rises through the low voltage region in which internal circuit of IC and the controller are unstable, so that device may not work properly due to an incomplete reset of internal circuit. To prevent this, the device has the feature of P.O.R. and LVCC. In the case of power up, keep the following conditions to ensure functions of P.O.R. and LVCC.

tR

Below 10ms

Below 100ms

- 1. It is necessary to be "SDA='H'" and "SCL='L' or 'H'".
- 2. Follow the recommended conditions of tR, tOFF, Vbot for the function of P.O.R. during power up.

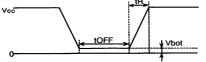
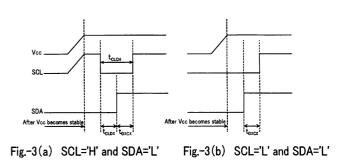


Fig.-2 Vcc RISING WAVEFORM

- Prevent SDA and SCL from being "High-Z". In case that condition 1. and/or 2. cannot be met, take following actions.
 - A) Unable to keep condition 1.
 (SDA is "LOW" during power up.)
 - → Control SDA ,SCL to be "HIGH" as Fig.-3(a), 3(b).
 - B) Unable to keep condition 2.
 - → After power becomes stable, execute software reset.
 - C) Unable to keep both conditions 1 and 2. \rightarrow Follow the instruction A first, then the instruction B.



♦ RECOMMENDED CONDITIONS OF tR, tOFF, Vbot

Vbot

Below 0.3V

Below 0.2V

tOFF

Above 10ms

Above 10ms

♦CAUTIONS ON USE

(1) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and action temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

(2) Vss electric potential

Set the voltage of Vss terminal lowest at any action condition. Make sure that each terminal voltage is lower than that of Vss terminal.

(3) Thermal design

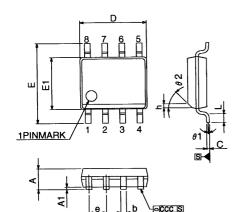
In consideration of permissible loss in actual use condition, carry out heat design with sufficient margin. (4) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and Vss owing to foreign matter, LSI may be destructed.

(5) Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.

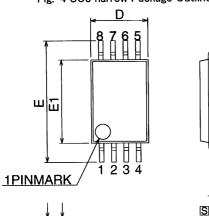
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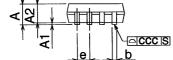
♦ PHYSICAL DIMENSION



	01		mm			inches	
	Symb.	Тур.	Min.	Max.	Тур.	Min.	Max.
	А	-	1.35	1.75	-	0.053	0.069
	A1	-	0.10	0.25	-	0.004	0.010
	b	-	0.33	0.51	-	0.013	0.020
	с	-	0.19	0.25	-	0.007	0.010
	D	-	4.80	5.00	-	0.189	0.197
	е	1.27	-	-	0.050	-	-
	E	-	5.80	6.20	-	0.228	0.244
	E1	-	3.80	4.00	-	0.150	0.157
	L	-	0.40	1.27	0.050	0.016	0.050
	θ1	-	0°	8°	-	0°	8°
	ccc	-	-	0.10	-	-	0.004
~	h	-	0.25	0.50	-	0.010	0.020
.	θ2	45°	-	-	45°	-	-

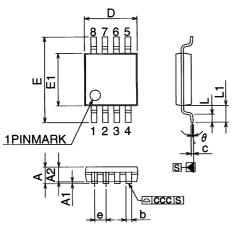
Notes 1.This drawing is subject to change without notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference JEDEC MS-012 variation AA. Fig.-4 SO8 narrow Package Outline





Notes 1.This drawing is subject to change without notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference JEDEC MO-153 variation AA.

Fig.-5 TSSOP Package Outline



Notes 1.This drawing is subject to change without notice. 2.Body dimensions do not include mold flash or protrusion, or gate burns. 3.Reference JEDEC MO-187 variation AA.

Fig.-6 TSSOP 3 × 3mm² Package Outline

♦ TSSOP8 Package size data

Sumb		mm			inches	
Symb.	Тур.	Min.	Max.	Тур.	Min.	Max.
A	-	-	1.200	-	-	0.0472
A1	-	0.050	0.150	-	0.0020	0.0059
A2	1.000	0.800	1.050	0.0394	0.0315	0.0413
b	-	0.190	0.300	-	0.0075	0.0118
С	-	0.090	0.200	-	0.0035	0.0079
D	3.000	2.900	3.100	0.1181	0.1142	0.1220
e	0.650	-	-	0.0256	-	-
E	6.400	6.200	6.600	0.2520	0.2441	0.2598
E1	4.400	4.300	4.500	0.1732	0.1693	0.1772
L	0.600	0.450	0.750	0.0236	0.0177	0.0295
L1	1.000	-	-	0.0394	-	-
ccc	-	-	0.100	-	-	0.0039
θ	-	0°	8°	-	0°	8°

♦ TSSOP8 3 × 3mm² Package size data

Ch	_	mm			inches	
Symb.	Тур.	Min.	Max.	Тур.	Min.	Max.
A	-	-	1.100	-	-	0.0433
A1	-	0.050	0.150	-	0.0020	0.0059
A2	0.850	0.750	0.950	0.0335	0.0295	0.0374
b	-	0.250	0.400	-	0.0098	0.0157
С	-	0.120	0.230	-	0.0047	0.0091
D	3.000	2.900	3.100	0.1181	0.1142	0.1220
e	0.650	-	-	0.0256	-	-
E	4.900	4.650	5.150	0.1929	0.1831	0.2028
E1	3.000	2.900	3.100	0.1181	0.1142	0.1220
L	0.550	0.400	0.700	0.0217	0.0157	0.0276
L1	0.950	-	-	0.0374	-	-
ccc	-	-	0.100	-	-	0.0039
θ	-	0°	6°	-	0°	6°

♦ SO8 narrow Package size data

Notes

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